

Hyperfast Rectifier, 15 A FRED Pt®



DPAK (TO-252AA)



FEATURES

- Hyperfast recovery time, extremely low Q_{rr}
- 175 °C maximum operating junction temperature
- For PFC CCM operation
- Low forward voltage drop
- Low leakage current
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see www.vishay.com/doc?999912



RoHS
COMPLIANT
HALOGEN
FREE

PRIMARY CHARACTERISTICS

| | |
|-----------------------|-----------------|
| $I_{F(AV)}$ | 15 A |
| V_R | 600 V |
| V_F at I_F | 1.5 V |
| t_{rr} (typ.) | 18 ns |
| T_J max. | 175 °C |
| Package | DPAK (TO-252AA) |
| Circuit configuration | Single |

DESCRIPTION / APPLICATIONS

State of the art hyperfast recovery rectifiers designed with optimized performance of forward voltage drop, hyperfast recovery time, and soft recovery.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for use in PFC boost stage in the AC/DC section of SMPS inverters or as freewheeling diodes. Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

ABSOLUTE MAXIMUM RATINGS

| PARAMETER | SYMBOL | TEST CONDITIONS | VALUES | UNITS |
|---|----------------|--|-------------|-------|
| Peak repetitive reverse voltage | V_{RRM} | | 600 | V |
| Average rectified forward current | $I_{F(AV)}$ | $T_C = 117\text{ °C}$ | 15 | A |
| Non-repetitive peak surge current | I_{FSM} | $T_J = 25\text{ °C}$ | 120 | |
| Peak repetitive forward current | I_{FM} | $T_C = 117\text{ °C}$, $f = 20\text{ kHz}$, $d = 50\%$ | 30 | |
| Operating junction and storage temperatures | T_J, T_{Stg} | | -55 to +175 | °C |

ELECTRICAL SPECIFICATIONS ($T_J = 25\text{ °C}$ unless otherwise specified)

| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
|-------------------------------------|---------------|--|------|------|------|---------------|
| Breakdown voltage, blocking voltage | V_{BR}, V_R | $I_R = 100\text{ }\mu\text{A}$ | 600 | - | - | V |
| Forward voltage | V_F | $I_F = 15\text{ A}$ | - | 2.3 | 3.2 | |
| | | $I_F = 15\text{ A}$, $T_J = 125\text{ °C}$ | - | 1.6 | 1.9 | |
| | | $I_F = 15\text{ A}$, $T_J = 150\text{ °C}$ | - | 1.5 | 1.8 | |
| Reverse leakage current | I_R | $V_R = V_R$ rated | - | - | 50 | μA |
| | | $T_J = 125\text{ °C}$, $V_R = V_R$ rated | - | - | 200 | |
| | | $T_J = 150\text{ °C}$, $V_R = V_R$ rated | - | - | 300 | |
| Junction capacitance | C_T | $V_R = 600\text{ V}$ | - | 11 | - | pF |
| Series inductance | L_S | Measured lead to lead 5 mm from package body | - | 8 | - | nH |



| DYNAMIC RECOVERY CHARACTERISTICS ($T_J = 25\text{ }^{\circ}\text{C}$ unless otherwise specified) | | | | | | |
|---|-----------|--|------|------|------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| Reverse recovery time | t_{rr} | $I_F = 1\text{ A}$, $dI_F/dt = 100\text{ A}/\mu\text{s}$, $V_R = 30\text{ V}$ | - | 18 | 22 | ns |
| | | $I_F = 1\text{ A}$, $dI_F/dt = 50\text{ A}/\mu\text{s}$, $V_R = 30\text{ V}$ | - | 22 | - | |
| | | $I_F = 15\text{ A}$, $dI_F/dt = 100\text{ A}/\mu\text{s}$, $V_R = 30\text{ V}$ | - | 17 | 32 | |
| | | $T_J = 25\text{ }^{\circ}\text{C}$ | - | 22 | - | |
| | | $T_J = 125\text{ }^{\circ}\text{C}$ | - | 38 | - | |
| Peak recovery current | I_{RRM} | $T_J = 25\text{ }^{\circ}\text{C}$ | - | 3.1 | - | A |
| | | $T_J = 125\text{ }^{\circ}\text{C}$ | - | 4.6 | - | |
| Reverse recovery charge | Q_{rr} | $T_J = 25\text{ }^{\circ}\text{C}$ | - | 37 | - | nC |
| | | $T_J = 125\text{ }^{\circ}\text{C}$ | - | 92 | - | |

| THERMAL - MECHANICAL SPECIFICATIONS | | | | | | |
|---|----------------|----------------------------|-----------|------|------|-----------------------------|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| Maximum junction and storage temperature range | T_J, T_{Stg} | | -55 | - | 175 | $^{\circ}\text{C}$ |
| Thermal resistance, junction to case per leg | R_{thJC} | | - | 1.4 | 1.8 | $^{\circ}\text{C}/\text{W}$ |
| Thermal resistance, junction to ambient per leg | R_{thJA} | | - | - | 70 | |
| Approximate weight | | | 0.3 | | | g |
| | | | 0.01 | | | oz. |
| Marking device | | Case style DPAK (TO-252AA) | 15EWX06FN | | | |

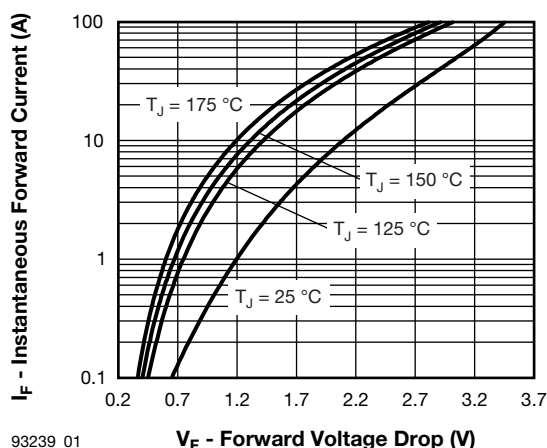


Fig. 1 - Typical Forward Voltage Drop Characteristics

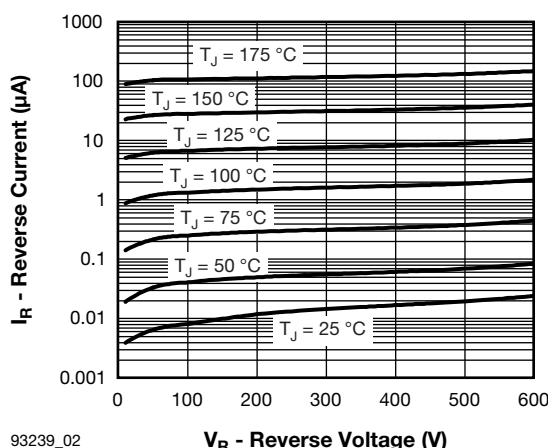


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

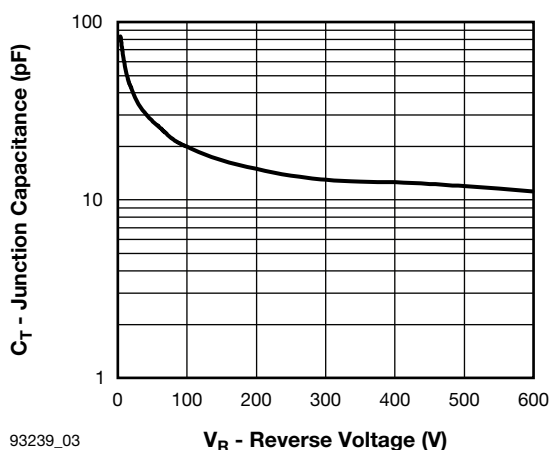


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

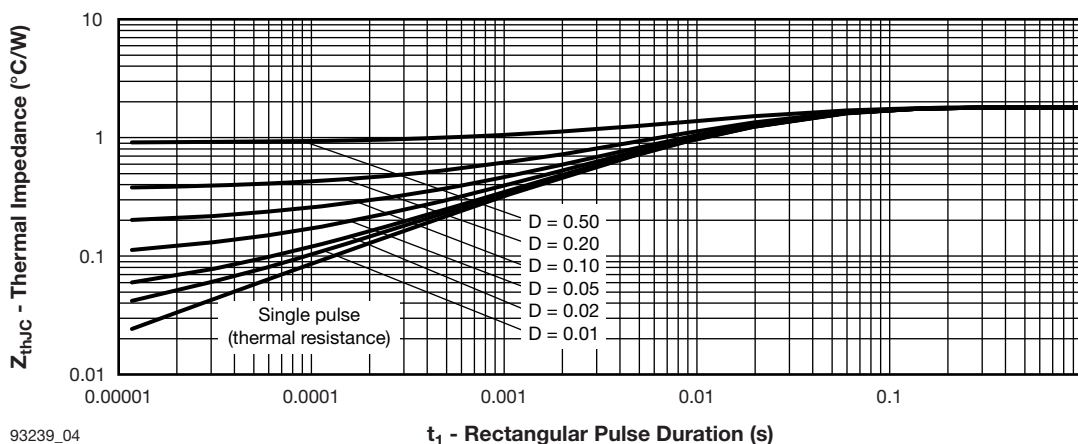
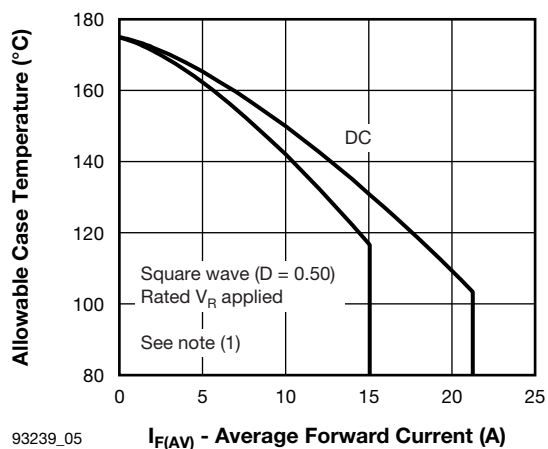

Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

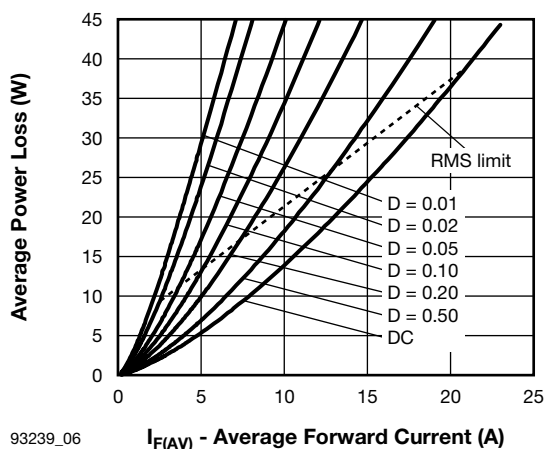
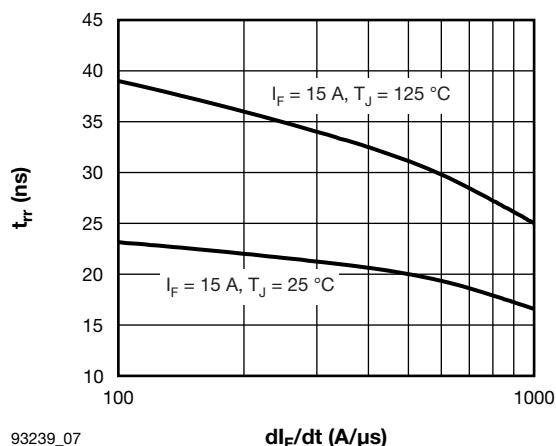
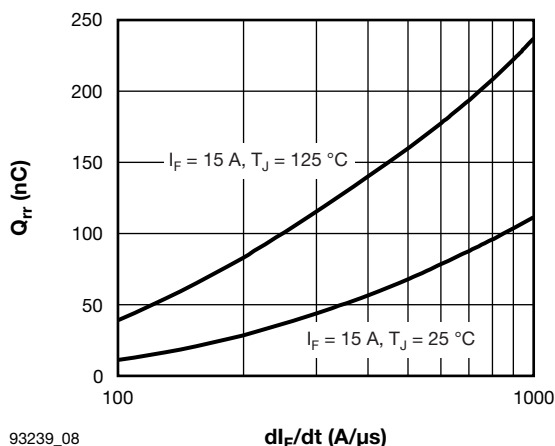


Fig. 6 - Forward Power Loss Characteristics


Fig. 7 - Typical Reverse Recovery Time vs. di_F/dt

Fig. 8 - Typical Stored Charge vs. di_F/dt
Note

- (1) Formula used: $T_C = T_J - (P_d + P_{dREV}) \times R_{thJC}$;
 P_d = forward power loss = $I_{F(AV)} \times V_{FM}$ at $(I_{F(AV)}/D)$ (see fig. 6);
 P_{dREV} = inverse power loss = $V_{R1} \times I_R (1 - D)$; I_R at V_{R1} = rated V_R

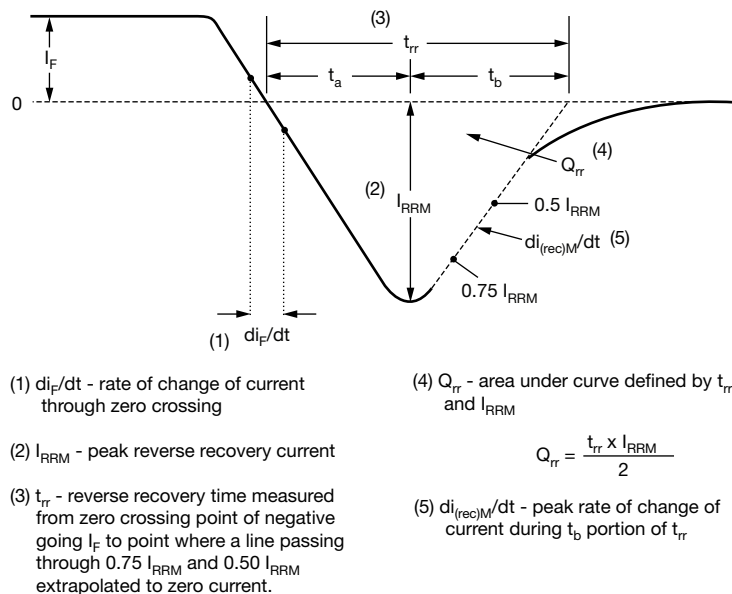


Fig. 9 - Reverse Recovery Waveform and Definitions

**ORDERING INFORMATION TABLE**

| | | | | | | | | | |
|-------------|------------|-----------|----------|----------|----------|-----------|-----------|------------|------------|
| Device code | VS- | 15 | E | W | X | 06 | FN | TRL | -M3 |
| | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 |

- | | | |
|----------|---|---|
| 1 | - | Vishay Semiconductors product |
| 2 | - | Current rating (15 = 15 A) |
| 3 | - | Circuit configuration: E = Single diode |
| 4 | - | Package identifier: W = D-PAK |
| 5 | - | X = hyperfast recovery time |
| 6 | - | Voltage rating (06 = 600 V) |
| 7 | - | FN = TO-252AA |
| 8 | - | <ul style="list-style-type: none">• None = tube• TR = tape and reel• TRL = tape and reel (left oriented)• TRR = tape and reel (right oriented) |
| 9 | - | Environmental digit: -M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free |

| ORDERING INFORMATION (Example) | | |
|---------------------------------------|----------------------|------------------------------|
| PREFERRED P/N | BASE QUANTITY | PACKAGING DESCRIPTION |
| VS-15EWX06FN-M3 | 75 | Antistatic plastic tube |
| VS-15EWX06FNTR-M3 | 2000 | 13" diameter reel |
| VS-15EWX06FNTRL-M3 | 3000 | 13" diameter reel |
| VS-15EWX06FNTRR-M3 | 3000 | 13" diameter reel |

| LINKS TO RELATED DOCUMENTS | |
|-----------------------------------|--|
| Dimensions | www.vishay.com/doc?95627 |
| Part marking information | www.vishay.com/doc?95176 |
| Packaging information | www.vishay.com/doc?95033 |
| SPIICE model | www.vishay.com/doc?96041 |

**D-PAK (TO-252AA) “M”****DIMENSIONS** in millimeters and inches

| SYMBOL | MILLIMETERS | | INCHES | | NOTES | SYMBOL | MILLIMETERS | | INCHES | | NOTES |
|--------|-------------|------|--------|-------|-------|--------|-------------|-------|------------|-------|-------|
| | MIN. | MAX. | MIN. | MAX. | | | MIN. | MAX. | MIN. | MAX. | |
| A | 2.18 | 2.39 | 0.086 | 0.094 | | e | 2.29 BSC | | 0.090 BSC | | |
| A1 | - | 0.13 | - | 0.005 | | H | 9.40 | 10.41 | 0.370 | 0.410 | |
| b | 0.64 | 0.89 | 0.025 | 0.035 | | L | 1.40 | 1.78 | 0.055 | 0.070 | |
| b2 | 0.76 | 1.14 | 0.030 | 0.045 | | L1 | 2.74 BSC | | 0.108 REF. | | |
| b3 | 4.95 | 5.46 | 0.195 | 0.215 | 3 | L2 | 0.51 BSC | | 0.020 BSC | | |
| c | 0.46 | 0.61 | 0.018 | 0.024 | | L3 | 0.89 | 1.27 | 0.035 | 0.050 | 3 |
| c2 | 0.46 | 0.89 | 0.018 | 0.035 | | L4 | - | 1.02 | - | 0.040 | |
| D | 5.97 | 6.22 | 0.235 | 0.245 | 5 | L5 | 1.14 | 1.52 | 0.045 | 0.060 | 2 |
| D1 | 5.21 | - | 0.205 | - | 3 | Ø | 0° | 10° | 0° | 10° | |
| E | 6.35 | 6.73 | 0.250 | 0.265 | 5 | Ø1 | 0° | 15° | 0° | 15° | |
| E1 | 4.32 | - | 0.170 | - | 3 | Ø2 | 25° | 35° | 25° | 35° | |

Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension uncontrolled in L5
- (3) Dimension D1, E1, L3 and b3 establish a minimum mounting surface for thermal pad
- (4) Section C - C dimension apply to the flat section of the lead between 0.13 and 0.25 mm (0.005 and 0.010") from the lead tip
- (5) Dimension D, and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (6) Dimension b1 and c1 applied to base metal only
- (7) Datum A and B to be determined at datum plane H
- (8) Outline conforms to JEDEC® outline TO-252AA



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